

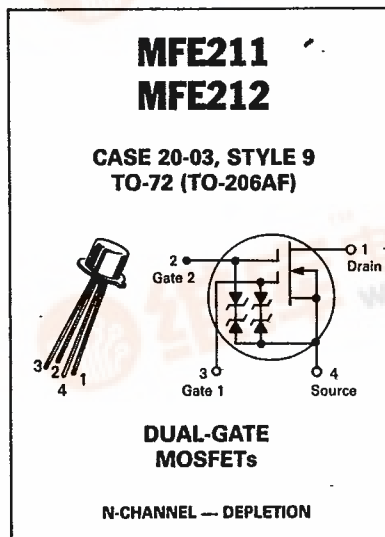
**N-CHANNEL DUAL-GATE  
SILICON-NITRIDE PASSIVATED  
MOS FIELD-EFFECT TRANSISTORS**

... high  $Y_{fs}$  depletion mode dual gate transistors designed for VHF amplifier and mixer applications.

- MFE211 — VHF Amplifier/IF Amplifier  
MFE212 — VHF Mixer
- High Forward Transfer Admittance —  $|Y_{fs}| = 17\text{--}40$  mmhos
- Low Reverse Transfer Capacitance —  $C_{rss} = 0.03$  pF (Max)
- Diode Protected Gates

**MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Drain-Source Voltage	$V_{DSX}$	20	Vdc
Drain-Gate Voltage	$V_{DG1}$ $V_{DG2}$	35 35	Vdc
Gate Current	$I_{G1}$ $I_{G2}$	$\pm 10$ $\pm 10$	mAdc
Drain Current — Continuous	$I_D$	50	mAdc
Total Power Dissipation @ $T_A = 25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_D$	360 2.4	mW mW/ $^\circ\text{C}$
Total Power Dissipation @ $T_C = 25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_D$	1.2 8.0	Watt mW/ $^\circ\text{C}$
Storage Channel Temperature Range	$T_{stg}$	$-65$ to $+200$	$^\circ\text{C}$
Junction Temperature Range	$T_J$	$-65$ to $+175$	$^\circ\text{C}$
Lead Temperature, $1/16"$ From Seated Surface for 10 Seconds	$T_L$	300	$^\circ\text{C}$



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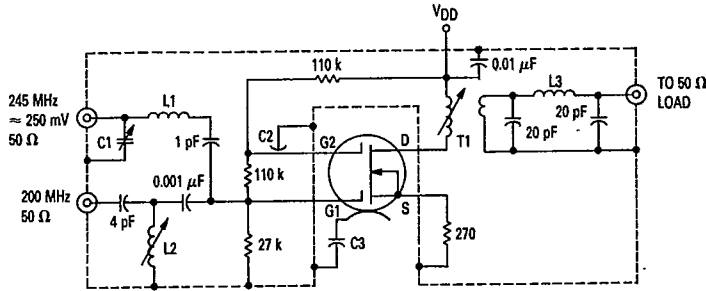
**ELECTRICAL CHARACTERISTICS** ( $T_A = 25^\circ\text{C}$  unless otherwise noted.)

Characteristic	Symbol	Min	Max	Unit
<b>OFF CHARACTERISTICS</b>				
Drain-Source Breakdown Voltage ( $I_D = 10 \mu\text{Adc}$ , $V_{G1S} = V_{G2S} = -4.0$ Vdc)	$V_{(BR)DSX}$	20	—	Vdc
Gate 1 — Source Breakdown Voltage(1) ( $I_{G1} = \pm 10$ mAdc, $V_{G2S} = V_{DS} = 0$ )	$V_{(BR)G1SO}$	$\pm 6.0$	—	Vdc
Gate 2 — Source Breakdown Voltage(1) ( $I_{G2} = \pm 10$ mAdc, $V_{G1S} = V_{DS} = 0$ )	$V_{(BR)G2SO}$	$\pm 6.0$	—	Vdc
Gate 1 to Source Cutoff Voltage ( $V_{DS} = 15$ Vdc, $V_{G2S} = 4.0$ Vdc, $I_D = 20 \mu\text{Adc}$ )	MFE211 MFE212 $V_{G1S(off)}$	$-0.5$ $-0.5$	$-5.5$ $-4.0$	Vdc
Gate 2 to Source Cutoff Voltage ( $V_{DS} = 15$ Vdc, $V_{G1S} = 0$ , $I_D = 20 \mu\text{Adc}$ )	MFE211 MFE212 $V_{G2S(off)}$	$-0.2$ $-0.2$	$-2.5$ $-4.0$	Vdc
Gate 1 Leakage Current ( $V_{G1S} = \pm 5.0$ Vdc, $V_{G2S} = V_{DS} = 0$ ) ( $V_{G1S} = -5.0$ Vdc, $V_{G2S} = V_{DS} = 0$ , $T_A = 150^\circ\text{C}$ )	$I_{G1SS}$	—	$\pm 10$ $-10$	mAdc $\mu\text{Adc}$
Gate 2 Leakage Current ( $V_{G2S} = \pm 5.0$ Vdc, $V_{G1S} = V_{DS} = 0$ ) ( $V_{G2S} = -5.0$ Vdc, $V_{G1S} = V_{DS} = 0$ , $T_A = 150^\circ\text{C}$ )	$I_{G2SS}$	—	$\pm 10$ $-10$	nAdc $\mu\text{Adc}$
<b>ON CHARACTERISTICS</b>				
Zero-Gate Voltage Drain Current(2) ( $V_{DS} = 15$ Vdc, $V_{G1S} = 0$ , $V_{G2S} = 4.0$ Vdc)	$I_{DSS}$	6.0	40	mAdc
<b>SMALL-SIGNAL CHARACTERISTICS</b>				
Forward Transfer Admittance(3) ( $V_{DS} = 15$ Vdc, $V_{G2S} = 4.0$ Vdc, $V_{G1S} = 0$ , $f = 1.0$ kHz)	$ Y_{fs} $	17	40	mmhos
Reverse Transfer Capacitance ( $V_{DS} = 15$ Vdc, $V_{G2S} = 4.0$ Vdc, $I_D = 10$ mAdc, $f = 1.0$ MHz)	$C_{rss}$	0.005	0.05	pF

(continued)







L1: 7 Turns #34, 1/4" diameter aluminum slug  
 L2: 5-1/2 Turns #20, 1/4" diameter aluminum slug  
 L3: 7 Turns #24, 1/4" diameter air core  
 C1: Arco type 462, 5-80 pF  
 C2: 0.001  $\mu$ F leadless disc  
 C3: 0.01  $\mu$ F leadless disc  
 T1: Pri: 25 Turns #30, close wound on 1/4" diameter form, type "J" slug  
 Sec: 4 Turns #30, centered over primary

Figure 3. 200 MHz-to-45 MHz Circuit for Conversion Power Gain for MFE212

TYPICAL CHARACTERISTICS

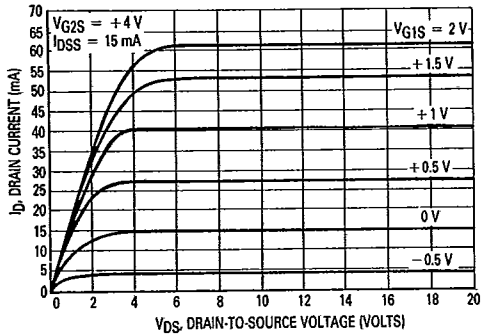


Figure 4. Drain Current versus Drain-to-Source Voltage

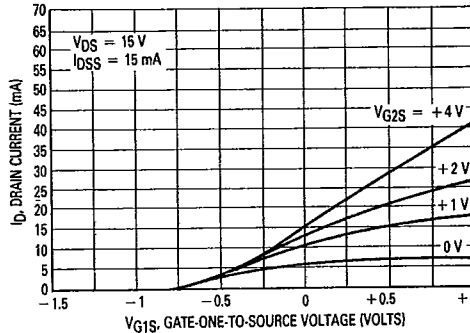


Figure 5. Drain Current versus Gate-One-to-Source Voltage

SMALL-SIGNAL COMMON-SOURCE PARAMETER

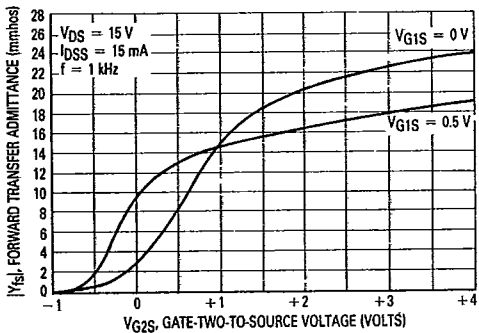


Figure 6. Forward Transfer Admittance versus Gate-Two-to-Source Voltage

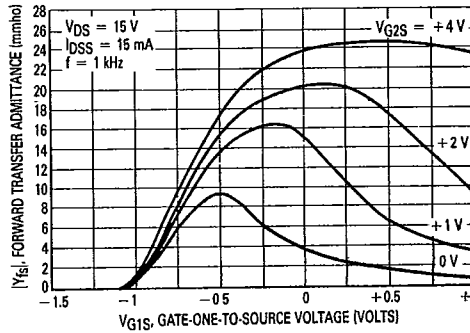


Figure 7. Forward Transfer Admittance versus Gate-One-to-Source Voltage

T-31-25

TYPICAL CHARACTERISTICS (continued)

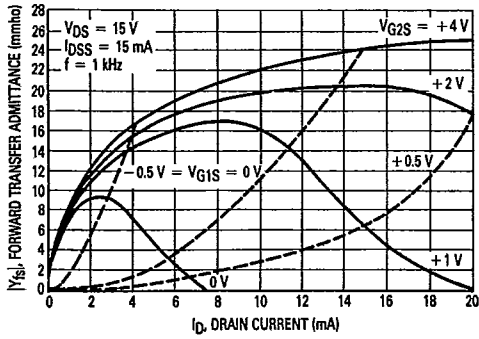


Figure 8. Forward Transfer Admittance versus Drain Current

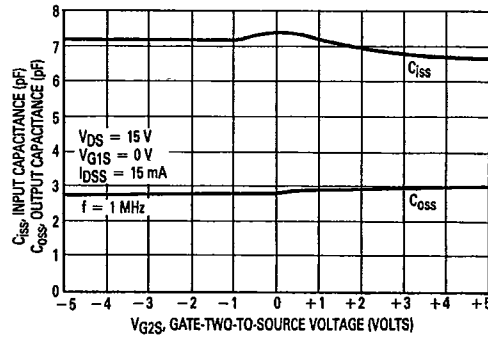


Figure 9. Input and Output Capacitance versus Gate-Two-to-Source Voltage

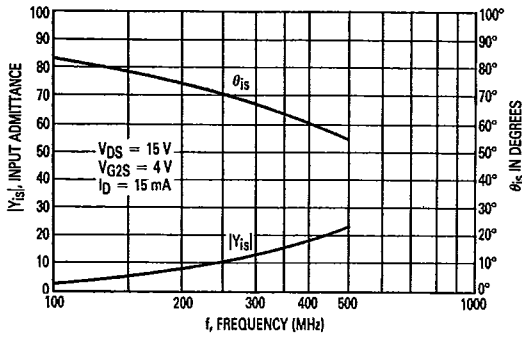


Figure 10. Small-Signal Gate-One Input Admittance versus Frequency

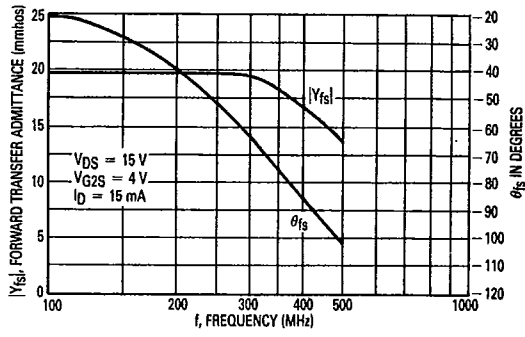


Figure 11. Small-Signal Forward Transfer Admittance versus Frequency

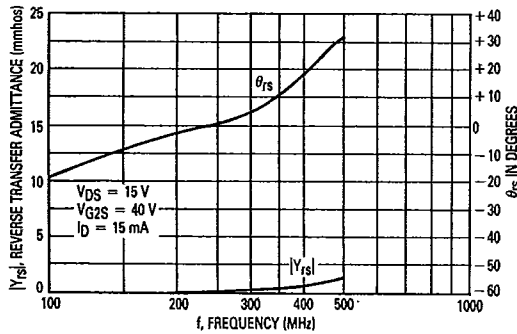


Figure 12. Small-Signal Gate-One Reverse Transfer Admittance versus Frequency

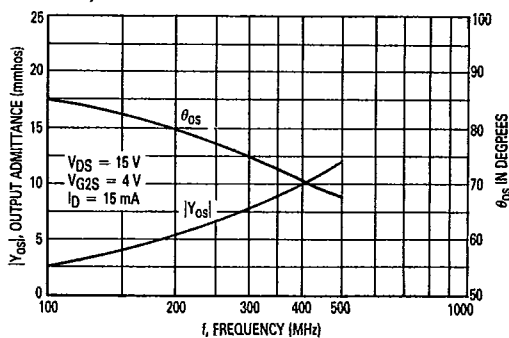


Figure 13. Small-Signal Gate-One Output Admittance versus Frequency

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TYPICAL CHARACTERISTICS (continued)

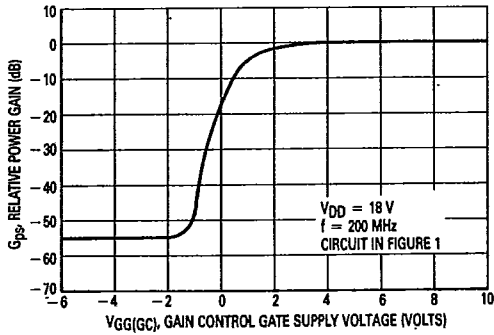


Figure 14. Relative Small-Signal Power Gain versus Gain Control Gate Supply Voltage MFE211

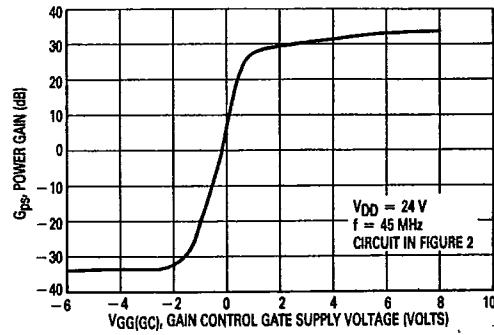


Figure 15. Small-Signal Common-Source Insertion Power Gain versus Gain Control Gate Supply Voltage

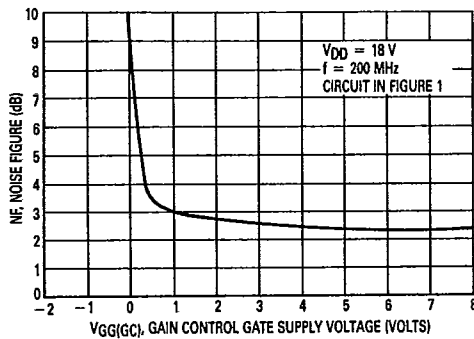


Figure 16. Common Source Spot Noise Figure versus Gain Control Gate Supply Voltage

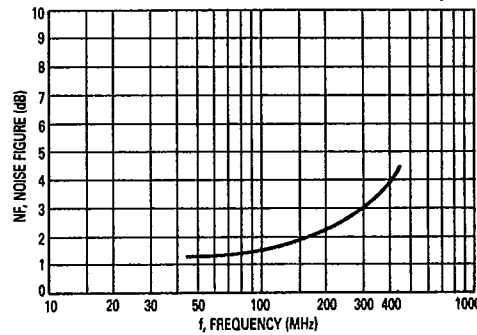


Figure 17. Optimum Spot Noise Figure versus Frequency

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